

WORKPIECE GRINDING METHOD

ABSTRACT

Provided is a workpiece grinding method that is applied when a circular plate-shaped workpiece which has a first surface and a second surface on an opposite side of the first surface is to be ground. The workpiece grinding method includes a first grinding step of grinding the workpiece to form a circular plate-shaped first thin plate portion and an annular first thick plate portion that surrounds the first thin plate portion and that has an inner side surface at least part of which is inclined with respect to the second surface, and a second grinding step of grinding the workpiece to form a circular plate-shaped second thin plate portion that is larger in diameter but thinner than the first thin plate portion and an annular second thick plate portion that surrounds the second thin plate portion.

[FIG. 6]